

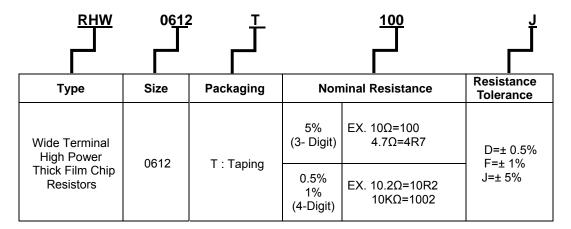
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1 Scope:

- 1.1 This specification is applicable to lead free and halogen free of RoHS directive for RHW series wide terminal thick film chip resistors.
- 1.2 The product is for general electronic purpose.

2 Explanation Of Part Numbers:

(EX)



3 General Specifications:

Туре	Rated Power	Max. Working	Max. Overload Voltage	T.C.R		ance Range
	At70°C	Voltage	Voltage	(ppm/℃)	D(±0.5%)F(±1%) E-24 \ E-96	J(±5%) E-24
DLIMOCAO	1W	200V	400V	±200	1Ω≦R<10Ω	1Ω≦R<10Ω
RHW0612	W0612 IVV 200V 400V	4000	±100	10Ω≦R≦10KΩ	10Ω≦R≦10KΩ	
Оре	erating Ter	nperature R	ange	-55°C ~ +155°C		

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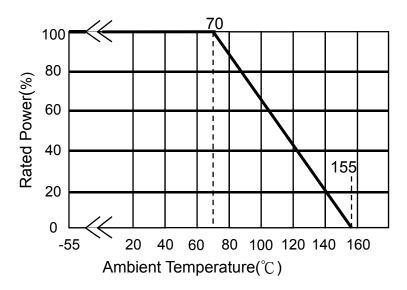


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3.1 Power Derating Curve:

Operating Temperature Range:- 55 ~155 ℃

If the ambient temperature exceeds 70 degrees centigrade to 155 degrees, the power can be modified by the curve as blow.



3.2 Voltage Rating:

Rated Voltage: DC voltage or AC voltage (rms) based on the rated power. The voltage can be calculated by the following formula. If the calculated value exceeds the Max voltage specified in the Table 3, the Max voltage rating is set as the voltage rating.

$$E = \sqrt{R \times P}$$

$$P = PC$$

$$P = NC$$

E= Rated voltage(V)
P= Power rating(W)

R= Nominal resistance(Ω)

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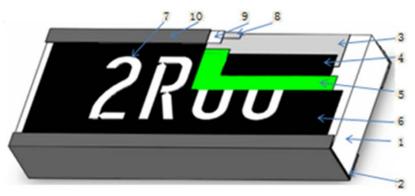
4 Dimensions:

Unit:mm



						Officialiti
Туре	Dimension Size Code	L	W	Н	L1	L2
RHW	0612	1.60±0.20	3.20±0.20	0.55±0.10	0.35±0.15	0.25±0.15

5 Structure Graph:



1	Ceramic substrate	6	2nd Protective coating
2	Bottom inner electrode	7	Marking
3	Top inner electrode	8	Terminal inner electrode
4	Resistive layer	9	Ni plating
5	1st Protective coating	10	Sn plating

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6 Reliability Test:

6.1 Electrical Performance Test

ltom	Conditions	Specifications	
Item	Conditions	Resistors	Jumper
		Refer to item 3.	NA
	TCR (ppm / $^{\circ}$ C) = R1 (72 - 71) ×10 ⁶	General specifications	
T	R1: Resistance at room temperature(Ω)		
Temperature Coefficient of	R2: Resistance at -55°C or +125°C (Ω)		
Resistance	T1: Room temperature(°ℂ)		
rtoolotarioo	T2:Temperature -55 $^{\circ}$ C or +125 $^{\circ}$ C($^{\circ}$ C).		
	Refer to JIS-C5201-1 4.8		
	RHW06 apply 2.5 times the rated voltage for 2 seconds		Refer to
	and let stand for more than 30 minutes before measuring		item 3.
	the resistance change rate.		general
Overload	(Rated voltage refer to item 3. general specifications)		specifica tions
	Refer to JIS-C5201-1 4.13		110115
		No short or burned on the appe	arance.
Dielectric	below) in +,- terminal for.		
Withstand Voltage	RHW06(0612) apply 400VAC 1 minute.		
Ü	Refer to JIS-C5201-1 4.7		
	Put it in the thermostat, apply 2.0 times rated voltage, 1		Refer to
	second ON, 25 seconds OFF, count 10000+400/-0 times,		item 3.
	take it out and stand for 60 minutes, then measure the		general
Overload	change of resistance value.		specifica tions
	Refer to JIS-C5201-1 4.13		uons

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6.2 Mechanical Performance Test

	nical Performance Test	Specifications	
Item	Conditions	Resistors	Jumper
•	Pre-treatment: The chip resistor was placed in the PCT machine, and the aging test was conducted for 4 hours under the saturation condition of 105°C, 100% humidity and 1.22×10 ⁵ Pa air pressure. Then, the chip resistor was placed at room temperature for 2 hours Test method: The resistor be immersed into solder pot in temperature 235±5°C for 2 sec. Then take out to observe its solder area under microscope. Refer to JIS-C5201-1 4.17	Solder coverage over 95%	
Resistance to Soldering Heat	Test method 1(Solder pot test): The tested resistor be immersed into molten solder of 260+5/-0°C for10+1/-0seconds, let stand for more than 1 hour before measuring the resistance change rate ○Test method 2 (Solder pot test): The tested resistor be immersed into molten solder of 260+5/-0°C for 30+1/-0seconds. Then remove and wash it to observe the solder area under a microscope. ○Test method 3 (Electric iron test): Preheating temperature: 350±10°C Electric iron preheating time: 3+1/-0 sec	Test item 1: (1)Variance rate on resistance	Refer to item 3. general specifica tions
Joint Strength of Solder	Solder chip resistors on to bending test plate and placed on the bending test machine. Apply pressure in the center of the test plate and measure the rate of change of resistance under load D:RHW0612=3mm Resistor Chip resistor (Arrount of band) Refer to JIS-C5201-1 4.33	△R%=±1.0%	Refer to item 3. general specifications

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6.3 Environmental Test

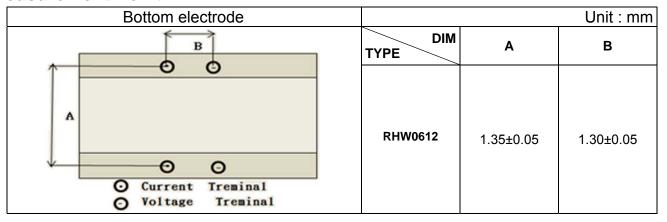
Item	Conditions	Specifications	
пеш	Conditions	Resistors	Jumper
Resistance to Dry Heat	Put tested resistor in the oven under temperature 155±5 °C for 1000 +48/-0 hours. Then take out and let stand for more than 1 hour before measuring the resistance change rate PS:RHW0612 for 125±3°C. Refer to JIS-C5201-1 4.25	<u>`</u> R=±2.0%	Refer to item 3. general specifications
Thermal Shock	Put chip resistors in the thermal shock machine ,and the temperature was -55°C for 15 minutes and +125°C for 15 minutes, the total of 300 times and then removed, let stand for more than 1 hour before measuring the resistance change rate. Testing Condition Lowest Temperature Temperature 125±5°C Temperature-retaining time Refer to MIL-STD 202 Method 107		Refer to item 3. general specifications
	Put the tested resistor in the constant temperature and humidity tank, under temperature 40±2°C, relative humidity 90~95% and load the rated voltage for 90 minutes on, 30 minutes off, total 1000 hours. Then take out and let stand for more than 1 hour before measuring the resistance change rate Refer to JIS-C5201-1 4.24		Refer to item 3. general specifications
Load Life	Put the tested resistor in the oven under temperature 70±2°C and load the rated voltage for 90 minutes on, 30 minutes off, total 1000 hours. Then take out and let stand for more than 1 hour before measuring the resistance change rate Refer toJIS-C5201-1 4.25	±5.0%	Refer to item 3. general specifications

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7 Measurement Point:



8 Plating Thickness:

8.1 Ni: \ge 2 μ m

 $8.2\,Sn(Tin){:}\!\ge\!3\mu\mathrm{m}$

8.3 Sn(Tin):Matte Sn

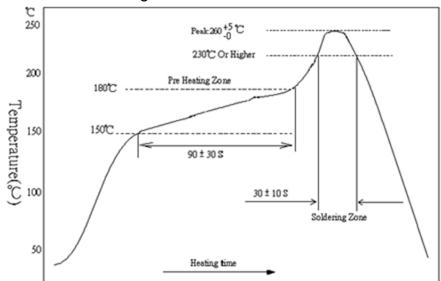
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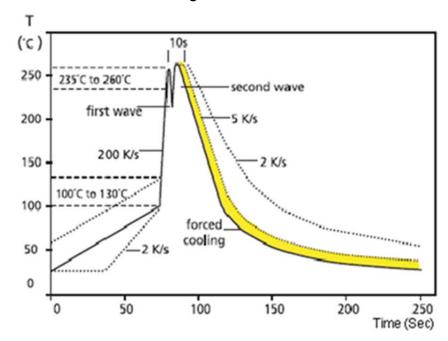
9 Technical application notes:(This is a recommendation ,please adjust it according to actual application)

- 9.1 Recommend Soldering Method:
 - 9.1.1 Lead Free IR Reflow Soldering Profile



Remark: The peak temperature of soldering heat is 260 +5/-0° for 10 seconds

9.1.2 Lead Free Double-Wave Soldering Profile



9.1.3 Soldering Iron: temperature 350°C±10°C, dwell time shall be less than 3 sec.

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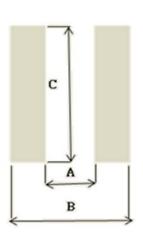


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Unit:mm

9.2 Land Pattern Design (For Reflow Soldering):

When a component is soldered, the resistance after soldering changes slightly depending on the size of the soldering area and the amount of soldering. When designing a circuit, it is necessary to consider the effect of a decrease or increase in its resistance.



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TYPE DIM	А	В	С
RHW0612	0.7	2.6	3.5

9.3 Environment Precautions:

This specification product is for general electronic use, ABCO will not be responsible for any damage, cost or loss caused by using this specification product in any special environment. If other applications, you need to confirm with ABCO.

If consumer intends to use our Company product in special environment or condition (including but not limited to those mentioned below), then will need to make individual recognition of product features and reliability accordingly.

- (a) Used in high temperature and humidity environment.
- (b) Exposed to sea breeze or other corrosive gas, such as Cl2 \ H2S \ NH3 \ SO2 and NO2.
- (c) Used in non-verified liquids including water, oil, chemical and organic solvents.
- (d) Using non-verified resin or other coating material to seal or coat our Company product.
- (e) After soldering, it is necessary to use water-soluble detergents to clean residual solder fluxes, even though no-clean fluxes are recommended.

9.4 Momentary Overload Precautions:

The product might be out of function when momentary overloaded. Please make sure to avoid momentary overloading while using and preserving

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9.5 Operation and Processing Precautions:

- (a) Avoid damage to the edge of resistor and protective layer caused by mechanical stress.
- (b) Handle with care when printing circuit board (PCB) is divided or fixed on support body, because bending of printing circuit board (PCB) mounting will make mechanical stress for resistors.
- (c) Make sure the power rating is under the limit when using the resistor. When power rating is over the limit, the resister will be overloaded. There might be machinery damage due to the climbing temperature.
- (d) If the resister will be exposed under massive impact load (shock wave) in a short period of time, the working environment must be set up well before use.
- (e) Please make evaluation and confirmation when the product is well used in your company and have a through consideration of it's fail-safe design to ensure the system safety.

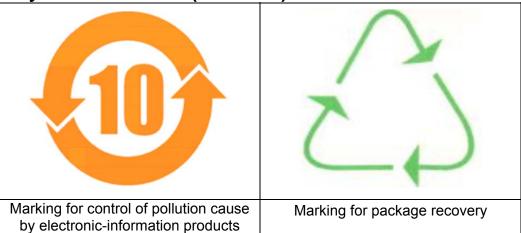
10 Stock period:

- 10.1The temperature condition must be controlled at 25±5℃,the R.H. must be controlled at 60±15%. The stock can maintain quality level in two years.
- 10.2Please avoid the mentioned harsh environment below when storing to ensure product performance and its weldability. Places exposed to sea breeze or other corrosive gas, such as Cl₂ \ H₂S \ NH₃ \ SO₂ and NO₂.
- 10.3When the product is moved and stored, please ensure the correct orientation of the box. Do not drop or squeeze the box. Otherwise, the electrode or the body of the product may be damaged.



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11 The carton packaged for electronic-information products is made by the symbol as follows: (For china)





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